TAI-TECH

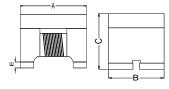
Wire Wound Type Common Mode Filter

WCM1210F2SF-900T04

1. Features

- 1. High common mode impedance at high frequency cause excellent noise suppression performance.
- 2. WCM1210F2SF series realizes small size and low profile. 1.2x1.0x0.9 mm.
- 3. 100% Lead(Pb) & Halogen-Free and RoHS compliant.
- 4. Operating temperature-40~+125 $^\circ\!\mathrm{C}$ (Including self temperature rise)

2. Dimension

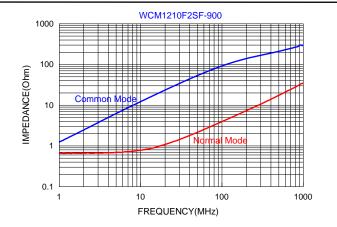


						T.	T.	
		Series	A(mm)	B(mm)	C(mm)	D1(mm)	D2(mm)	E(mm)
		1210F2SF	1.2±0.2	1.0±0.2	0.9 max.	0.35±0.1	0.35±0.1	0.03 min.
3. Part Numberin	g							
WCM 1210	- 2	S	F	-	900	Т	04	
A B C	D D	E	F		G	Н	Ι	
A: Series								
B: Dimension								
C: Material	Ferrite C	Core						
D: Number of Lines	2=2 line	s						
E: Type	S=Shiel	ded , N=Un	shielded					
F: Lead free								
G: Impedance	900=90	Ω						
H: Packaging	T=Tapin	g and Reel						
I: Rated Current	04=400	mA						

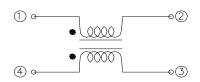
4. Specification

TAI-TECH Part Number	Common mode Impedance (Ω)	Test Frequency (MHz)	DC Resistance (Ω) max.	Rated Current (mA)max.	Rated Volt. (Vdc) max.	Withstand Volt. (Vdc) max.	IR (Ω) min.
WCM1210F2SF-900T04	90±25%	100	0.30	400	50	125	10M



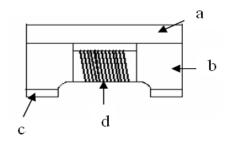


5. Schematic Diagram



6. Materials

No.	Description	Specification
a.	Upper Plate	Ferrite
b.	Core	Ferrite Core
с	Termination	Ag/Ni/Sn
d	Wire	Enameled Copper Wire



7. Reliability and Test Condition

Item	Performance	Test Condition
Operating temperature	-40~+125°C (Including self - temperature rise)	
Storage temperature	-40~+125℃ (on board)	
Electrical Performance Te	est	L
Z(common mode)		Agilent-4291A+ Agilent -16197A
DCR	Refer to standard electrical characteristics list.	Agilent-4338B
I.R.	_	Agilent4339
Temperature Rise Test	Rated Current ΔT 40℃Max	1.Applied the allowed DC current. 2.Temperature measured by digital surface thermometer
Reliability Test	-	
Life Test		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles) Temperature : 125±2°C Applied current : rated current Duration : 1000±12hrs Measured at room temperature after placing for 24±2 hrs
Load Humidity		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Humidity: 85±2%R.H, Temperature: 85°C ±2°C Duration: 1000hrs Min. with 100% rated current Measured at room temperature after placing for 24±2 hrs
Moisture Resistance	Appearance : No damage. Impedance : within±15% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value	 Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020DClassification Reflow Profiles 1. Baked at50°C for 25hrs, measured at room temperature after placing for 4 hrs. 2. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs. 3. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs. 4. Keep at 25°C 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1–2 hrs.
Thermal shock		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Condition for 1 cycle Step1 : $-40\pm2^{\circ}$ 30 ±5 min Step2 : $25\pm2^{\circ}$ ≤ 0.5 min Step3 : $125\pm2^{\circ}$ C 30 ±5 min Number of cycles : 500 Measured at room temperature after placing for 24 ±2 hrs
Vibration		Oscillation Frequency: 10 ~ 2K ~ 10Hz for 20 minutes Equipment : Vibration checker Total Amplitude:1.52mm±10% Testing Time : 12 hours(20 minutes, 12 cycles each of 3 orientations)。

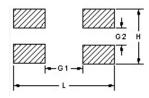
Item	Performance	Test Condition					
Bending	Appearance ∶ No damage. Impedance ∶ within±15% of initial value	Shall be mounted on a FR4 substrate of the following dimensions: >=0805 inch(2012mm):40x100x1.2mm <0805 inch(2012mm):40x100x0.8mm Bending depth: >=0805 inch(2012mm):1.2mm <0805 inch(2012mm):0.8mm duration of 10 sec.					
	Q : Shall not exceed the specification value. RDC : within $\pm 15\%$ of initial value and shall not exceed the specification value	Type Peak Normal duration (D) G's (ms) Wave form Velocity change (Vi)ft/sec					
Shock		SMD 50 11 Half-sine 11.3					
		Lead 50 11 Half-sine 11.3					
Solder ability	More than 95% of the terminal electrode should be covered with solder。	Preheat: 150°C,60sec.₀ Solder: Sn96.5% Ag3% Cu0.5% Temperature: 245±5°C ∘ Flux for lead free: Rosin. 9.5% ∘ Dip time: 4±1sec ∘ Depth: completely cover the termination					
Resistance to Soldering Heat		Depth: completely cover the termination Temperature ramp/immersion and emersion rate Number of heat cycles 260 ±5 (solder temp) 10 ±1 25mm/s ±6 mm/s 1					
Terminal Strength	Appearance : No damage. Impedance : within±15% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value e	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles With the component mounted on a PCB with the device to be tested, apply a force(>0805:1kg, <=0805:0.5kg)to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.					
		substrate press tool shear force					

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8. Soldering and Mounting

8-1. Recommended PC Board Pattern

	WCM1210F2S
L(mm)	1.55
H(mm)	1.10
G1(mm)	0.65
G2(mm)	0.30



8-2. Soldering

Mildly activated rosin fluxes are preferred. TAI-TECH terminations are suitable for all wave and re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

8-2.1 Lead Free Solder re-flow:

Recommended temperature profiles for re-flow soldering in Figure 1.

8-2.2 Soldering Iron(Figure 2):

- Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.
- Preheat circuit and products to 150 $^\circ\!\mathrm{C}$ • Never contact the ceramic with the iron tip • Use a 20 watt soldering iron with tip diameter of 1.0mm · Limit soldering time to 4~5 sec.
 - 1.0mm tip diameter (max) · 350℃ tip temperature (max)

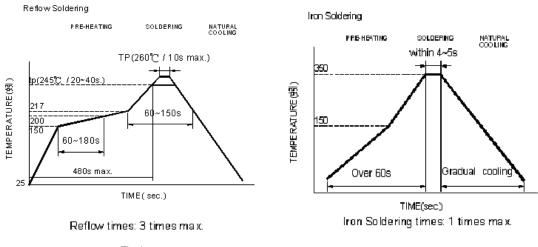
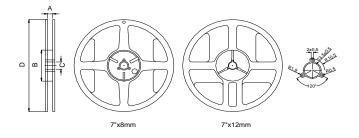


Fig.1

Fig.2

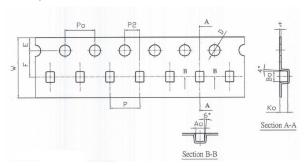
9. Packaging Information

9-1. Reel Dimension



Туре	A(mm)	B(mm)	C(mm)	D(mm)
7"x8mm	9.0±0.5	60±2	13.5±0.5	178±2

9-2. Tape Dimension / 8mm

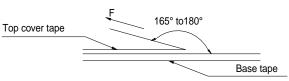


	Series	size	W(mm)	P(mm)	E(mm)	F(mm)	P2(mm)	D(mm)	P0(mm)	A0(mm)	B0(mm)	K0(mm)	t(mm)
ſ	WCM1210F2S	1210	8.00±0.10	4.00±0.10	1.75±0.10	3.50±0.05	2.00±0.05	1.50+0.10/-0.00	4.00±0.10	1.12±0.10	1.40±0.10	1.05±0.10	0.22±0.05

9-3. Packaging Quantity

Chip size	Chip/Reel	Inner Box	Middle Box	Carton
WCM1210F2S	3000	15000	75000	150000

9-4. Tearing Off Force



The force for tearing off cover tape is 15 to 80 grams in the arrow direction under the following conditions.

Room Temp.	Room Humidity	Room atm	Tearing Speed	
(°C)	(%)	(hPa)	mm/min	
5~35	45~85	860~1060	300	

Application Notice

- Storage Conditions(component level)
 - To maintain the solderability of terminal electrodes:
 - 1. TAI-TECH products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
 - 2. Temperature and humidity conditions: Less than 40 $^\circ\!\mathrm{C}$ $\,$ and 60% RH.
 - 3. Recommended products should be used within 12 months form the time of delivery.
 - $\ensuremath{\mathsf{4}}.$ The packaging material should be kept where no chlorine or sulfur exists in the air.

Transportation

- 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

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